



# **PRODUCT DATASHEET**



- EMC 2-PIN SMD
- 2016 0.52t Series
- Red (630nm)

Release Date: 21 November 2022 Version: A1.2





NOR20S37

# **APPLICATIONS:**

- Decorative Lighting
- Portable Lighting
- Outdoor Lighting

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- Commercial Lighting
- Architectural Lighting

# 2016 0.52t Series



# **FEATURES:**

- Package: TOP View EMC White SMT Package
- Forward Current: 40mA
- Forward Voltage (typ.): 2.1V
- Luminous Flux (typ.): 5.5lm@40mA
- Colour: Red
- Wavelength: 620-635nm
- Viewing angle: 120°
- Materials:
  - Die: AlInGaP
  - Resin: Silicon (Water Clear)
  - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+105°C
- Grouping parameters:
  - Forward Voltage
  - Luminous Flux
  - Dominant Wavelength
- Soldering methods: Reflow
- MSL Level: 3 according to J-STD020
- Packing: 8mm tape with Max.5000/reel, ø165mm (6.5")



# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	50	mA
Pulse Forward Current (width≤100µS; duty≤1/10)	IFP	75	mA
Power Dissipation	PD	130	mW
Reverse Voltage	VR	5	V
Reverse Current @5V	IR	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM: MIL-STD-883 C 2)	ESD	1000	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т <sub>stg</sub>	-40~+105	°C
Soldering Temperature (10s)	Tsld	260	°C

## Electrical & Optical Characteristics (Ta=25°C)

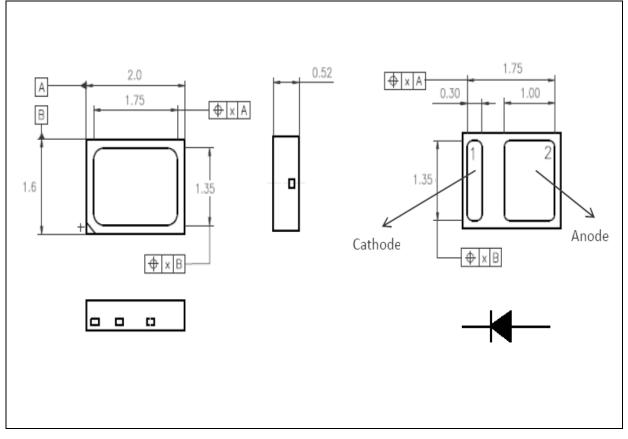
Daramatar	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	$V_{\text{F}}$	1.8	2.1	2.6	V	I <sub>F</sub> =40mA
Luminous Flux	Φv	2	5.5		lm	I⊧=40mA
Dominant Wavelength	$\lambda_{\text{D}}$	620		635	nm	I <sub>F</sub> =40mA
Viewing Angle	2 <b>θ</b> 1/2		120		deg	I⊧=40mA

1. Luminous flux ( $\Phi_V$ ) ±7%, Forward Voltage (V<sub>F</sub>) ±0.1V



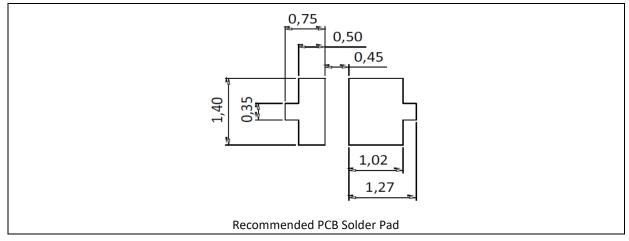
# **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- **2.** Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



# **BINNING GROUPS:**

Code	Min.	Max.	Unit
V1820	1.8	2.0	
V2022	2.0	2.2	V
V2224	2.2	2.4	v
V2426	2.4	2.6	

## Forward Voltage Classifications (I<sub>F</sub> = 40mA):

#### Luminous Flux Classifications (I<sub>F</sub> = 40mA):

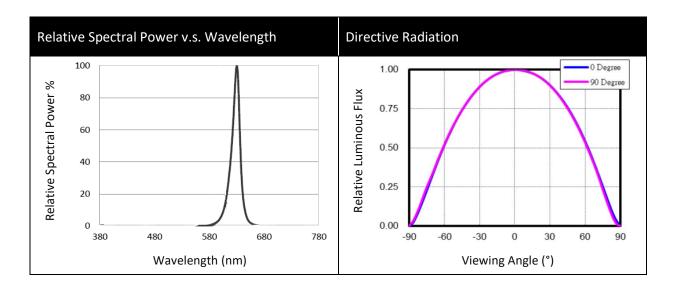
Code	Min.	Max.	Unit
AB	2	4	
AC	4	6	lm
AD	6	8	

## Dominant Wavelength Classifications (I<sub>F</sub> = 40mA):

Code	Min.	Max.	Unit
R1	602	625	
R2	625	630	nm
R3	630	635	

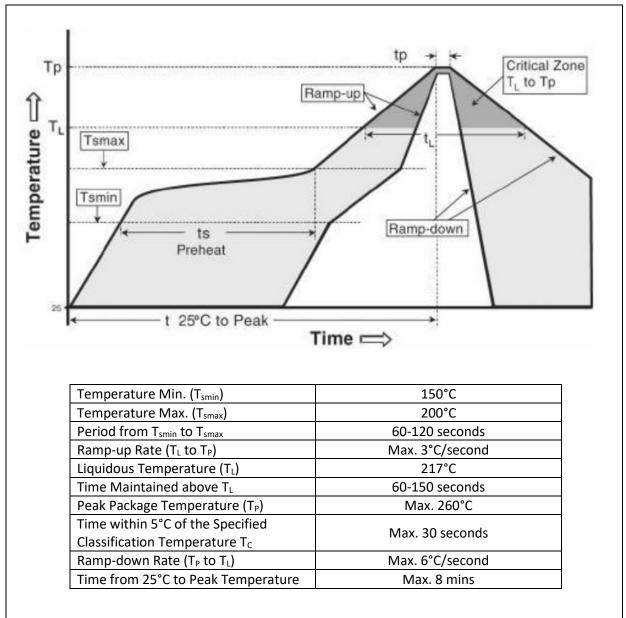


# **ELECTRO-OPTICAL CHARACTERISTICS:**





# **RECOMMENDED SOLDERING PROFILE:**



Reflow Lead-free Solder:

Note:

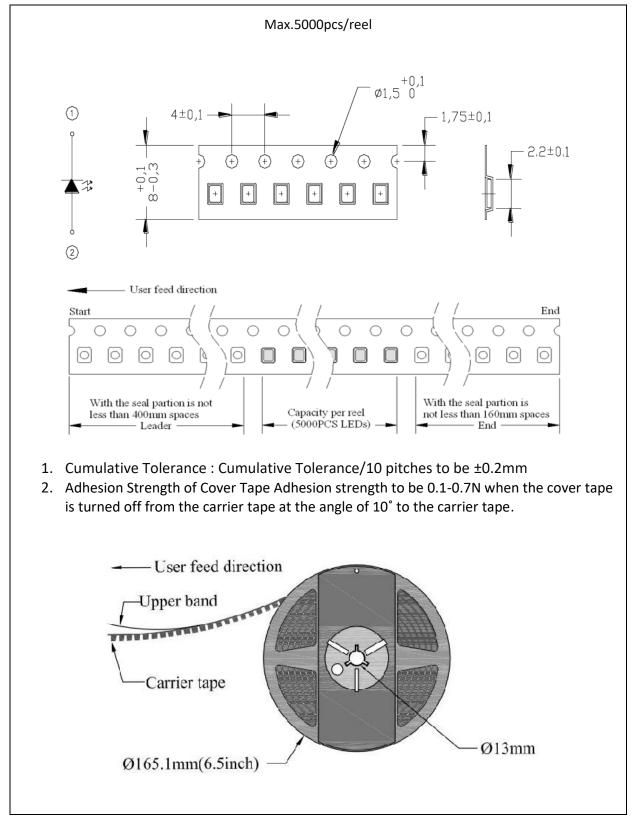
- 1. Maximum reflow soldering: 2 times within 24 hours.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

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# **PACKING SPECIFICATION:**

#### Reel Dimension:



# **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

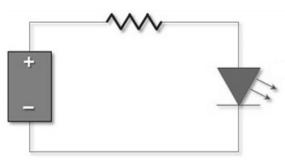
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

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# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	14/12/2016	Datasheet set-up.
A1.1	10/05/2017	Revised spectrum graphic.
A1.2	21/11/2022	Update bin tables.

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